

MJD32C

Low voltage PNP power transistor

Datasheet – production data

Features

- Surface-mounting TO-252 power package in tape and reel
- Complementary to the NPN type MJD31C

Application

 General purpose linear and switching equipment

Description

The device is manufactured in planar technology with "base island" layout. The resulting transistor shows exceptional high gain performance coupled with very low saturation voltage.



Figure 1. Internal schematic diagram



| Order code | Marking | Package | Packaging |
|------------|---------|---------|---------------|
| MJD32CT4 | MJD32C | DPAK | Tape and reel |

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This is information on a product in full production.

1 Electrical ratings

| Table 2. | Absolute | maximum | ratings |
|----------|----------|---------|---------|
| | Absolute | maximum | raungs |

| | 5 | | |
|------------------|---|------------|------|
| Symbol | Parameter | Value | Unit |
| V _{CBO} | Collector-base voltage $(I_E = 0)$ | -100 | V |
| V _{CEO} | Collector-emitter voltage $(I_B = 0)$ | -100 | V |
| V _{EBO} | Emitter-base voltage ($I_{C} = 0$) | -5 | V |
| Ι _C | Collector current | -3 | А |
| I _{CM} | Collector peak current | -5 | А |
| Ι _Β | Base current | -1 | А |
| P _{TOT} | Total dissipation at $T_c = 25 \ ^{\circ}C$ | 15 | W |
| T _{STG} | Storage temperature | -65 to 150 | °C |
| TJ | Max. operating junction temperature | 150 | °C |

Table 3. Thermal data

| Symbol | Parameter | Value | Unit |
|--|--------------------------------------|-------|------|
| R _{thJC} | Thermal resistance junction-case max | 8.3 | °C/W |
| R _{thJPCB} ⁽¹⁾ Thermal resistance junction-pcb max | | 50 | °C/W |

1. When mounted on FR-4 board of 1 inch², 2 oz Cu.



2 Electrical characteristics

 T_{case} = 25 °C unless otherwise specified.

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--------------------------------------|---|--|----------|------|------|------|
| I _{CES} | Collector cut-off current (V _{BE} = 0) | V _{CE} = - 100 V | | - | -20 | μA |
| I _{CEO} | Collector cut-off current (I _B = 0) | V _{CB} = - 60 V | | - | -50 | μA |
| I _{EBO} | Emitter cut-off current (I _C = 0) | V _{EB} = - 5 V | | - | -0.1 | mA |
| V _{CEO(sus)} ⁽¹⁾ | Collector-emitter sustaining voltage (I _B = 0) | I _C = - 30 mA | -100 | - | | v |
| V _{CE(sat)} ⁽¹⁾ | Collector-emitter saturation voltage | I _C = - 3 A I _B = - 375 mA | | - | -1.2 | v |
| V _{BE(on)} ⁽¹⁾ | Base-emitter on voltage | $I_{C} = -3 A$ $V_{CE} = -4 V$ | | - | -1.8 | V |
| h _{FE} | DC current gain | | 25 10 | - | 50 | |

 Table 4.
 Electrical characteristics

1. Pulse test: pulse duration ≤300 µs, duty cycle ≤2 %

2.1 Electrical characteristic (curves)









 $h_{FE} = \frac{0.617460}{T_{J} = 150 \,^{\circ}C} + \frac{T_{J} = 25 \,^{\circ}C}{T_{J} = 25 \,^{\circ}C} + \frac{100}{T_{J} = -40 \,^{\circ}C} + \frac{100}{T_{J} = -$



 $h_{FE} = 10$

T_J = 25 °C

– V_{CE (sat)} (V)

1

0.1

0.01

0.01



1

 $T_1 = -40$ °C

T_J =150 °C

DG17470

- |_c (A)







Figure 8. Base-emitter on voltage

0.1

Figure 9. Resistive load switching time (on)





(off) DG17510 t (n s) $V_{CC} = -30V$ $h_{FE} = 10$ V_{BE(off)}=4.3V $-I_{B(on)} = I_{B(off)}$ ts 1000 t_f 100 10 L 0 0.5 1 1.5 2 2.5 - I_C (A)

Figure 10. Resistive load switching time (off)

2.2 Test circuits





- 1. Fast electronic switch
- 2. Non-inductive resistor





Figure 12. Inductive load switching test circuit

- 1. Fast electronic switch
- 2. Non-inductive resistor
- 3. Fast recovery rectifier



3 Package mechanical data

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| Table 5. | DPAK (TO-252) mechanical data |
|----------|-------------------------------|
| | |

| Dim. | mm | | | | |
|------|------|------|-------|--|--|
| | Min. | Тур. | Max. | | |
| A | 2.20 | | 2.40 | | |
| A1 | 0.90 | | 1.10 | | |
| A2 | 0.03 | | 0.23 | | |
| b | 0.64 | | 0.90 | | |
| b4 | 5.20 | | 5.40 | | |
| С | 0.45 | | 0.60 | | |
| c2 | 0.48 | | 0.60 | | |
| D | 6.00 | | 6.20 | | |
| D1 | | 5.10 | | | |
| E | 6.40 | | 6.60 | | |
| E1 | | 4.70 | | | |
| e | | 2.28 | | | |
| e1 | 4.40 | | 4.60 | | |
| Н | 9.35 | | 10.10 | | |
| L | 1 | | 1.50 | | |
| L1 | | 2.80 | | | |
| L2 | | 0.80 | | | |
| L4 | 0.60 | | 1 | | |
| R | | 0.20 | | | |
| V2 | 0° | | 8° | | |









| | Таре | | | Reel | | |
|--------|------|------|------|-----------|------|--|
| Dim. | n | nm | Dim. | mm | | |
| Diili. | Min. | Max. | | Min. | Max. | |
| A0 | 6.8 | 7 | А | | 330 | |
| B0 | 10.4 | 10.6 | В | 1.5 | | |
| B1 | | 12.1 | С | 12.8 | 13.2 | |
| D | 1.5 | 1.6 | D | 20.2 | | |
| D1 | 1.5 | | G | 16.4 | 18.4 | |
| Е | 1.65 | 1.85 | N | 50 | | |
| F | 7.4 | 7.6 | Т | | 22.4 | |
| K0 | 2.55 | 2.75 | | | | |
| P0 | 3.9 | 4.1 | | Base qty. | 2500 | |
| P1 | 7.9 | 8.1 | | Bulk qty. | 2500 | |
| P2 | 1.9 | 2.1 | | | | |
| R | 40 | | | | | |
| Т | 0.25 | 0.35 | | | | |
| W | 15.7 | 16.3 | | | | |

 Table 6.
 DPAK (TO-252) tape and reel mechanical data

Figure 14. DPAK footprint^(a)



a. All dimensions are in millimeters

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4 Revision history

Table 7.Document revision history

| Date | Revision | Changes |
|-------------|----------|----------------------------------|
| 25-Jun-2007 | 1 | Initial release. |
| 09-Nov-2009 | 2 | Updated package mechanical data. |
| 14-Jan-2010 | 3 | Modified Table 3 on page 2. |
| 04-Jun-2012 | 4 | Updated: mechanical data |



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